intersil

HGTG32N60E2

JEDEC STYLE TO-247

N-CHANNEL ENHANCEMENT MODE

Package

COLLECTO

(BOTTOM SIDE METAL)

Terminal Diagram

April 1995

32A, 600V N-Channel IGBT

EMITTER

COLLECTOR

GATE

Features

- 32A, 600V
- Latch Free Operation
- Typical Fall Time 600ns
- · High Input Impedance
- Low Conduction Loss

Description

The IGBT is a MOS gated high voltage switching device combining the best features of MOSFETs and bipolar transistors. The device has the high input impedance of a MOSFET and the low on-state conduction loss of a bipolar transistor. The much lower on-state voltage drop varies only moderately between +25°C and +150°C.

IGBTs are ideal for many high voltage switching applications operating at frequencies where low conduction losses are essential, such as: AC and DC motor controls, power supplies and drivers for solenoids, relays and contactors.

This device incorporates generation two design techniques which yield improved peak current capability and larger short circuit withstand capability than previous designs.

PACKAGING AVAILABILITY

PART NUMBER	PACKAGE	BRAND		
HGTG32N60E2	TO-247	G32N60E2		
NOTE: When ordering use the entire part number				

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Absolute Maximum Ratings T_C = +25°C, Unless Otherwise Specified

	HGTG32N60E2	UNITS
Collector-Emitter Voltage BV _{CES}	600	V
Collector-Gate Voltage $R_{GE} = 1M\Omega$ V_{CGR}	600	V
Collector Current Continuous at $T_c = +25^{\circ}C$ I_{c25}	50	А
at $V_{GE} = 15V$, at $T_{C} = +90^{\circ}C$ I_{C90}	32	А
Collector Current Pulsed (Note 1)I _{CM}	200	А
Gate-Emitter Voltage Continuous V _{GES}	±20	V
Gate-Emitter Voltage Pulsed V _{GEM}	±30	V
Switching Safe Operating Area at T _J = +150°C	200A at 0.8 BV _{CES}	-
Power Dissipation Total at $T_{C} = +25^{\circ}C$ P_{D}	208	W
Power Dissipation Derating $T_C > +25^{\circ}C$	1.67	W/ºC
Operating and Storage Junction Temperature Range	-55 to +150	°C
Maximum Lead Temperature for SolderingTL	260	°C
Short Circuit Withstand Time (Note 2)at V _{GE} = 15Vt _{SC}	3	μs
at V _{GE} = 10V	15	μs
NOTES:		
1. Repetitive Rating: Pulse width limited by maximum junction temperature.		
2. $V_{CE(PEAK)} = 360V$, $T_C = +125^{\circ}C$, $R_{GE} = 25\Omega$.		
INTERSIL CORPORATION IGBT PRODUCT IS COVERED BY ONE OR MORE O	OF THE FOLLOWING U.S. P.	ATENTS:

()								
INTERSI	L CORPORATIO	N IGBT PRODUC	CT IS COVERED	BY ONE OR MC	ORE OF THE FO	LOWING U.S. P	PATENTS:	
4,364,073	4,417,385	4,430,792	4,443,931	4,466,176	4,516,143	4,532,534	4,567,641	
4,587,713	4,598,461	4,605,948	4,618,872	4,620,211	4,631,564	4,639,754	4,639,762	
4,641,162	4,644,637	4,682,195	4,684,413	4,694,313	4,717,679	4,743,952	4,783,690	
4,794,432	4,801,986	4,803,533	4,809,045	4,809,047	4,810,665	4,823,176	4,837,606	
4,860,080	4,883,767	4,888,627	4,890,143	4,901,127	4,904,609	4,933,740	4,963,951	
4.969.027								

CAUTION: These devices are sensitive to electrostatic discharge; follow proper IC Handling Procedures.

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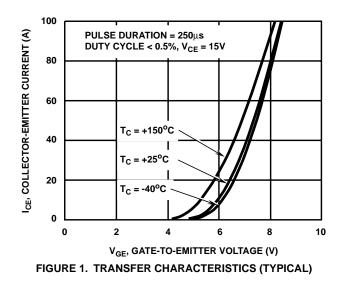
		TEST CONDITIONS $I_{C} = 250\mu$ A, $V_{GE} = 0V$		LIMITS			
PARAMETERS	SYMBOL BV _{CES}			MIN 600	TYP -	MAX	UNITS
Collector-Emitter Breakdown Voltage							
Collector-Emitter Leakage Voltage	I _{CES}	$V_{CE} = BV_{CES}$	T _C = +25°C	-	-	250	μA
		$V_{CE} = 0.8 \text{ BV}_{CES}$	T _C = +125 ^o C	-	-	4.0	mA
Collector-Emitter Saturation Voltage	V _{CE(SAT)}	$I_{\rm C} = I_{\rm C90},$	T _C = +25°C	-	2.4	2.9	V
		V _{GE} = 15V	T _C = +125 ^o C	-	2.4	3.0	V
Gate-Emitter Threshold Voltage	V _{GE(TH)}	$I_{C} = 1mA,$ $V_{CE} = V_{GE}$	T _C = +25 ^o C	3.0	4.5	6.0	V
Gate-Emitter Leakage Current	I _{GES}	$V_{GE} = \pm 20V$		-	-	±500	nA
Gate-Emitter Plateau Voltage	V _{GEP}	$I_{C} = I_{C90}, V_{CE} = 0.5 \text{ BV}_{CES}$		-	6.5	-	V
On-State Gate Charge	Q _{G(ON)}	$I_{C} = I_{C90},$ $V_{CE} = 0.5 \text{ BV}_{CES}$	V _{GE} = 15V	-	200	260	nC
			V _{GE} = 20V	-	265	345	nC
Current Turn-On Delay Time	t _{D(ON)}	$\label{eq:L} \begin{array}{l} {\sf L} = 500 \mu {\sf H}, {\sf I}_{\sf C} = {\sf I}_{{\sf C}90}, {\sf R}_{\sf G} = 25 \Omega, \\ {\sf V}_{\sf G{\sf E}} = 15 {\sf V}, {\sf T}_{\sf J} = +125^{\circ} {\sf C}, \\ {\sf V}_{\sf C{\sf E}} = 0.8 {\sf BV}_{\sf C{\sf E}{\sf S}} \end{array}$		-	100	-	ns
Current Rise Time	t _{RI}			-	150	-	ns
Current Turn-Off Delay Time	t _{D(OFF)} I			-	630	820	ns
Current Fall Time	t _{FI}	1	-	620	800	ns	
Turn-Off Energy (Note 1)	W _{OFF}	1		-	3.5	-	mJ
Thermal Resistance	R _{θJC}			-	0.5	0.6	°C/W

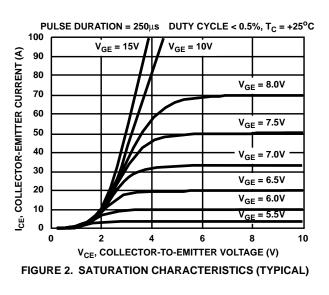
Electrical Specifications $T_c = +25^{\circ}C$, Unless Otherwise Specified

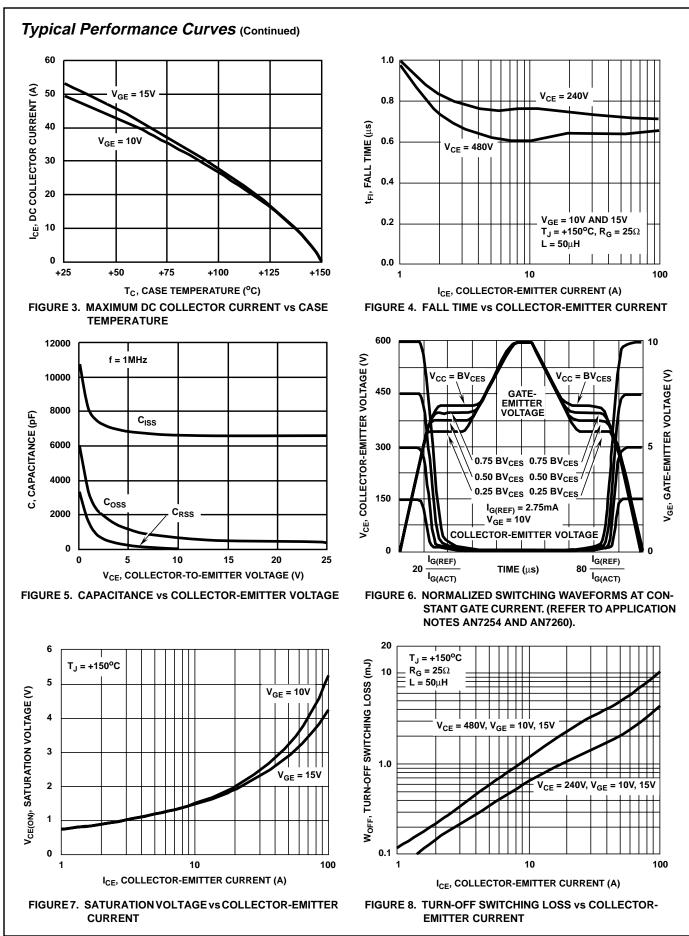
NOTE:

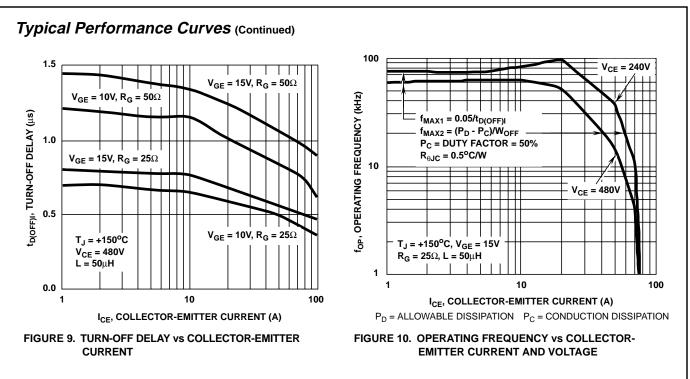
1. Turn-Off Energy Loss (W_{OFF}) is defined as the integral of the instantaneous power loss starting at the trailing edge of the input pulse and ending at the point where the collector current equals zero ($I_{CE} = 0A$) The HGTG32N60E2 was tested per JEDEC standard No. 24-1 Method for Measurement of Power Device Turn-Off Switching Loss. This test method produces the true total Turn-Off Energy Loss.

Typical Performance Curves









Operating Frequency Information

Operating frequency information for a typical device (Figure 10) is presented as a guide for estimating device performance for a specific application. Other typical frequency vs collector current (I_{CE}) plots are possible using the information shown for a typical unit in Figures 7, 8 and 9. The operating frequency plot (Figure 10) of a typical device shows f_{MAX1} or f_{MAX2} whichever is smaller at each point. The information is based on measurements of a typical device and is bounded by the maximum rated junction temperature.

 f_{MAX1} is defined by $f_{MAX1} = 0.05/t_{D(OFF)I}$, $t_{D(OFF)I}$ deadtime (the denominator) has been arbitrarily held to 10% of the onstate time for a 50% duty factor. Other definitions are possible, $t_{D(OFF)I}$ is defined as the time between the 90% point of the trailing edge of the input pulse and the point where the collector current falls to 90% of its maximum value. Device turn-off delay can establish an additional

frequency limiting condition for an application other than T_{JMAX} . $t_{D(OFF)I}$ is important when controlling output ripple under a lightly loaded condition.

 f_{MAX2} is defined by f_{MAX2} = $(P_D - P_C)/W_{OFF}$. The allowable dissipation (P_D) is defined by P_D = $(T_{JMAX} - T_C)/R_{\theta JC}$. The sum of device switching and conduction losses must not exceed P_D . A 50% duty factor was used (Figure 10) so that the conduction losses (P_C) can be approximated by P_C = $(V_{CE} \times I_{CE})/2$. W_{OFF} is defined as the sum of the instantaneous power loss starting at the trailing edge of the input pulse and ending at the point where the collector current equals zero (I_{CE} - 0A).

The switching power loss (Figure 10) is defined as $f_{MAX1} \times W_{OFF}$. Turn on switching losses are not included because they can be greatly influenced by external circuit conditions and components.

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